

ITM1050-series

SPECIFICATIONS OF TFT-LCD MODULE

This specification applies to the TFT-Module series ITM1050. This series supports the WVGA - 800(H) x 480(V) screen format and 65k colors. Furthermore the module support a lot of graphic commands, resistive touch screen, external keypad, backlight driving circuit and extended power supply.

The series ITM1050 is suited very well to realize own applications with very low expenditure in all current bus systems (8/16-bit, 3/4-wire SPI, I2C).

Index

Item	Description	Link	Page
1.	Features	↗	2
2.	Mechanical Specifications	↗	2
3.	Outline Dimensions	↗	2
4.	Numbering System	↗	3
5.	Absolute Maximum Ratings	↗	3
6.	Interface Pin Description	↗	4
7.	Hardware Settings	↗	5
8.	Optical Characteristics	↗	6
9.	Electrical Characteristics	↗	6
10.	Interface Characteristics	↗	7
10.1.	Parallel Interface	↗	7
10.2.	Serial Interface	↗	7
11.	Instructions / Commands	↗	8
11.1.	General Descriptions	↗	8
11.2.	Init of Module	↗	9
11.3.	Drive Backlight	↗	9
11.4.	Set Active Window	↗	10
11.5.	Draw Pixel/Dot	↗	10
11.6.	Draw Line	↗	10
11.7.	Draw Rectangle	↗	10
11.8.	Draw Rectangle with rounded corners	↗	11
11.9.	Draw Triangle	↗	11
11.10.	Draw Circle	↗	11
11.11.	Draw Ellipse	↗	12
11.12.	Draw Segment of Ellipse	↗	12
11.13.	Draw Text (Internal Font-ROM)	↗	13~15
11.14.	Draw Text (External Font-ROM)	↗	16
11.15.	Command Scroll	↗	16
11.16.	Command Write Transparent BTE	↗	17
11.17.	Command Move Transparent BTE	↗	17
11.18.	Image Handling	↗	18~19
12.	Quality Specifications	↗	20

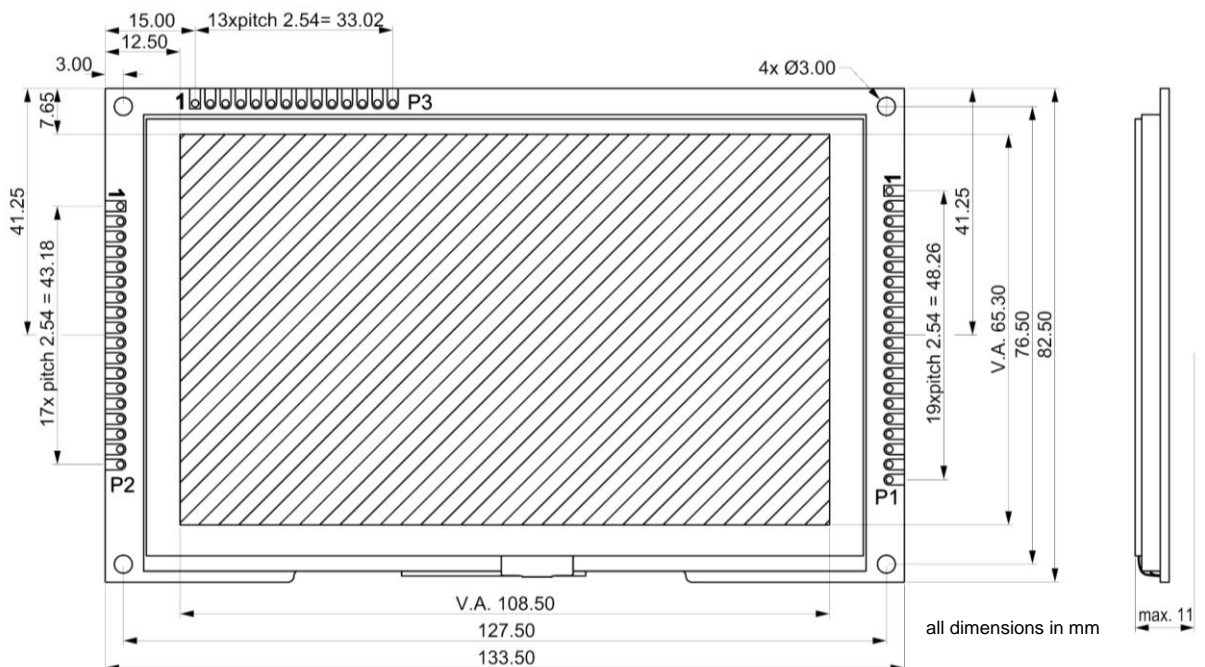
1. Features

1. Display format: 800x480 dots matrix graphic (WVGA)
2. LCD controller: RA8875
3. Power supply: +3.3VDC
4. Display Modes: TFT
5. Colors: 65k
6. Backlight: LED-white
7. Interfaces: 8/16-bit, SPI 3-wire/4-wire, IIC
8. General functions: Touch control
Backlight control
Up to 20 key control
Graphic functions
Internal FONT-ROM (ISO/IEC 8859-1...8859-4)
9. Options: Onboard DC/DC (max. 36VDC power supply)
Touch Screen (resistive, projective capacitive)
Up to 32MByte FLASH-memory on board
Additional Font-IC
Front bezel

2. Mechanical Specifications

Module size	133.5mm(L) * 82.5mm(W) * Max11.0(H)mm
Viewing area	108.5mm(L) * 65.3mm(W)
Dot size (RGB)	0.135mm(L) * 0.135mm(W)
Weight	Tbd.

3. Outline Dimensions



technical changes reserved

[back to page 1 \(Index\)](#)

4. Numbering System

ITM1050A – TRBX – EIxxx



1	ITM	Indicate the TFT Module products	
2	*	define series of TFT-module <ul style="list-style-type: none"> • 1 included LCD controller only • 2 included microcontroller for customer use • 3 included microcontroller with interpreter (see item 6 in this table) 	
3	***	<ul style="list-style-type: none"> • 035 3.5" 320x240 • 043 4.3" 480x272 • 050 5.0" 800x480 • 056 5.6" 640x480 • 057 5.7" 320x240 • 060 6.0" 800x480 • 064 6.4" 640x480 • 070 7.0" 800x480 • 085 8.5" 800x480 • 102 10.2" 800x480 	
4	Ax ~ Zx		Series No.
5	TR	with Touch Screen resistive	Extensions
	TC	with Touch Screen capacitive	
	TP	with Touch Screen projective capacitive	
	DC	with optional onboard power supply (max 36.0VDC)	
	M16	with additional onboard Memory 16MByte	
	M32	with additional onboard Memory 32MByte	
	F	additional font-IC (contact IbS Sperling)	
	B	with front bezel	
6	EI000-999	module series with extended intelligence and additional modules, such like: <ul style="list-style-type: none"> • digital I/O-modules • analog I/O-modules • Interfaces (USB, RSxxx, CAN, Fast SPI,...) • WEBserver • Camera • WLAN,... 	Extensions

5. Absolute Maximum Ratings

Item	Symbol	Standard			Unit
Power voltage	VDD-VSS	0	-	3.6	V
Input voltage	VIN	VSS	-	VDD	
Operating temperature range	TOP	-20	-	+70	°C
Storage temperature range	TST	-30	-	+80	

DC characteristics

Item		Symbol	Condition	Standard value			Unit
				Min.	Typ.	Max.	
Supply voltage for	Logic	$V_{DD} - V_{SS}$	$T_a = 25^\circ\text{C}$ $V_{DD} = 3.3\text{V}$	3.0	3.3	3.6	V
Supply current for	Logic	I_{DD}		-	tbd		mA
Input voltage		H: level		0.8VDD	VDD	-	V
Output voltage	L: level	V_{IL}		0	-	GND +0.4	
	H: level	V_{OH}		0.8x VDD	-	VDD	

6. Interface Pin Description [\(see also Page 7/24\)](#)

Interface connector P1 (standard interface)

Pin No.	Symbol	External connection	Function
1	UIN	Power supply	Power supply (+3.3VDC) for logic for LCM (see also options-DC)
2	GND		Signal ground for LCM (GND)
3	A0	MPU	Register select
4	/WR	MPU	Write enable signal
5	/RD	MPU	Read enable signal
6	GND	Power supply	Signal ground for LCM (GND)
7	/CS	MPU	Chip enable signal
8	GND	Power supply	Signal ground for LCM (GND)
9	/RES	MPU	Reset signal
10~17	DB0~DB7	MPU	Data bus line
18	GND	Power supply	Signal ground for LCM (GND)
19	INT	MPU	Interrupt of module (see spec RA8875)
20	WAIT	MPU	Busy of module

Interface connector P2 (extended interface)

Pin No.	Symbol	External connection	Function
1	UIN	Power supply	Power supply (+3.3VDC) for logic for LCM (see also options-DC)
2	GND		Signal ground for LCM (GND)
3	PWM2	MPU	Output PWM2
4~11	DB8~DB15	MPU	Data bus line
12	CS	MPU	SPI chip select signal IIC not used
13	SDO	MPU	SPI 3-wire: bidirectional Data IIC 4-wire: Data output not used
14	SDI	MPU	SPI Data input IIC bidirectional Data
15	SCL	MPU	SPI clock input IIC clock input
16	GND	Power supply	Signal ground for LCM (GND)
17	PROG	MPU	Program memory of module
18	SELFLA	MPU	Select memory on module

Interface connector P3/P3.1 (Key interface)

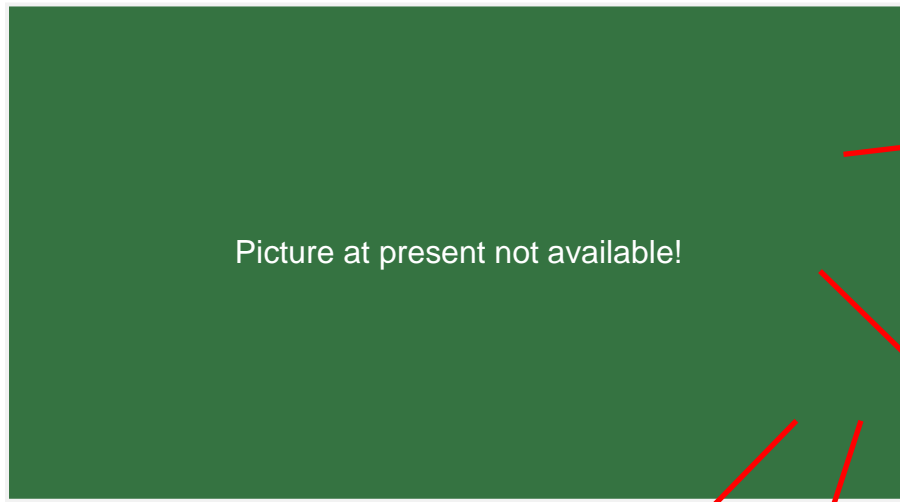
Pin No.	Symbol	External connection	Function
1	UOUT	Power supply	Power supply output (3.3V/max 80mA)
2~6	KI0~KI4	KEY	Keypad Data Line
7~10	KO0~KO3	KEY	Keypad Strobe Line
11	GPIX	~	General Purpose Input
12	GPOX	~	General Purpose Output
13	GND	Power supply	Signal ground for LCM (GND)
14	GND	Power supply	Signal ground for LCM (GND)

[back to page 1 \(Index\)](#)

7. Hardware Settings

Following pictures show the possibilities of hardware settings which customer could use to adjust interfaces, addresses a.s.o.

Backside of module:



Set key interface (presetting):

Jumper	Setting	Function
W6	open	K10 = H ^{*1}
	closed	K10 = L ^{*2}
W7	open	K11 = H ^{*1}
	closed	K11 = L ^{*2}
W8	open	K12 = H ^{*1}
	closed	K12 = L ^{*2}
W9	open	K13 = H ^{*1}
	closed	K13 = L ^{*2}
W10	open	K14 = H ^{*1}
	closed	K14 = L ^{*2}

^{*1} pulled with 47k to internal VDD(3.3V)

^{*2} direct connected to GND

Picture at present not available!

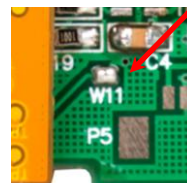


Set interface and addresses:

Jumper	Setting	Function
W1	open	I2C-address A0=H
	closed	I2C-address A0=L
W2	open	I2C-address A1=H
	closed	I2C-address A1=L

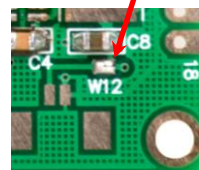
Set MCU interface:

Jumper	Setting	Function
W11	open	6800
	closed	8080



Set U_{IN} (Power supply):

Jumper	Setting	Function
W12	open	max. 36VDC (optional)
	closed	VDD=3.3VDC (default)

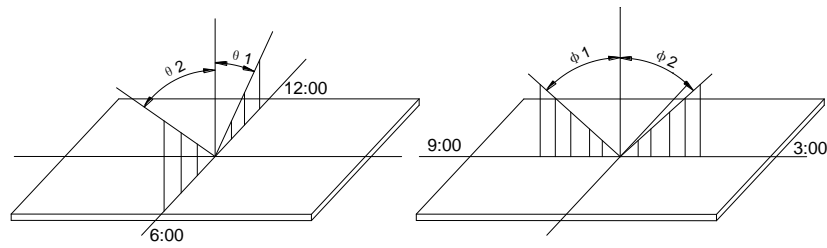


Jumper	Setting	NC	I2C	3-SPI	4-SPI
W3	open	-	x	-	x
	closed	x	-	x	-
W4	open	-	x	x	-
	closed	x	-	-	x

Jumper	Setting	Function
W5	open	select serial interface
	closed	select parallel interface

[back to page 1 \(Index\)](#)

8. Optical Characteristics

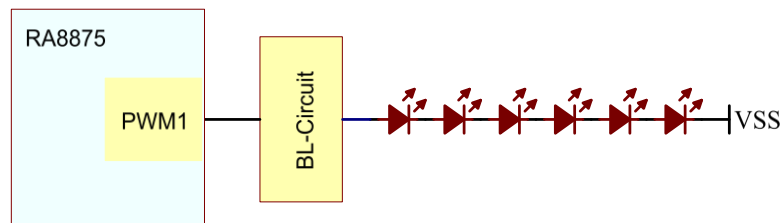


Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Viewing angle	$\Theta 1$	$Cr \geq 10$	30	70	-	deg
	$\Theta 2$		50	50	-	
	$\Phi 1$		50	70	-	
	$\Phi 2$		50	70	-	
Contrast ratio	Cr	$\Theta = 0^\circ$	-	600	-	-
Response time (rise)	Tr	25°C	-	25	40	ms
Response time (fall)	Tr	25°C	-	25	50	
Uniformity	U		75	80	-	%
Luminance	L		-	280	-	cd/m ²

9. Electrical Characteristics

BACKLIGHT CIRCUIT DIAGRAM

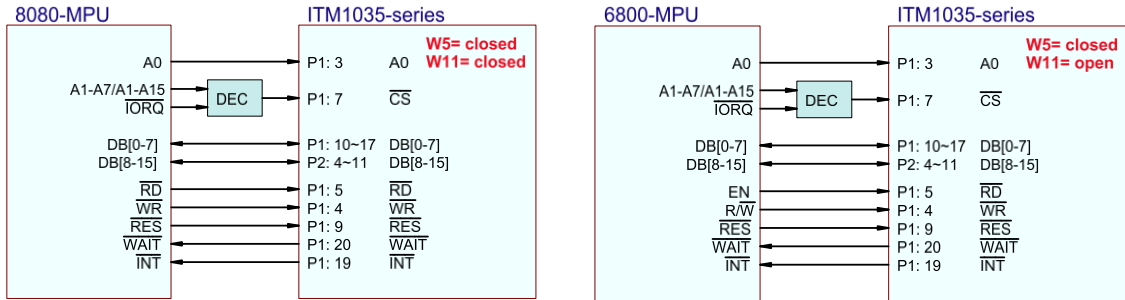
Note: Backlight is driven direct from LCD controller with pin U_{IN} .
No external connection is possible!



10. Interface Characteristics

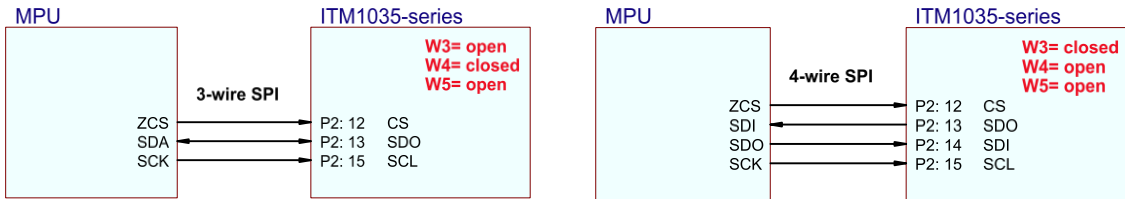
For full details, please refer to original spec of RA8875 V16!

10.1 Parallel Interface

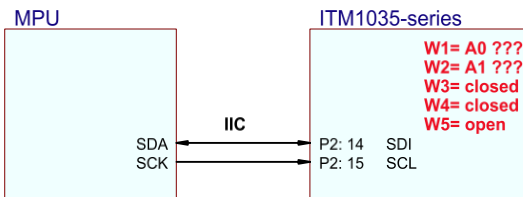


10.2 Serial Interface

10.2.1 Interfacing SPI



10.2.2 Interfacing I²C



- [📄 back to page 4 \(Interface Pin Description\)](#)
- [📄 back to page 1 \(Index\)](#)

11. Instructions / Commands

For detailed information of RA8875, please refer also for original specification of controller!

11.1 General Description

Parameter	Description	
X	X – position	10bit
Y	Y – position	9bit
X0	X – position	10bit, 1 st position → left
Y0	Y – position	9bit, 1 st position → top
X1	X – position	10bit, 2 nd position → right
Y1	Y – position	9bit, 2 nd position → bottom
Rad	Radius	8bit
Rh	horizontal radius	10bit
Rv	vertical radius	9bit
Col	RAIO-color value	8 or 16bit
Seg	Ellipse-segment	2bit
R	color-red	5bit
G	color-green	6bit
B	color-blue	5bit

Agreements for colors:

8-bit colors: R2 - R1 - R0 - G2 - G1 - G0 - B1 - B0 (Bit7...Bit0)

16-bit colors: 1st cycle: R4 - R3 - R2 - R1 - R0 - G5 - G4 - G3 (Bit7...Bit0)
 2nd cycle: G2 - G1 - G0 - B4 - B3 - B2 - B1 - B0 (Bit7...Bit0)

11.2 Init of Module (ITM1050)

Function	Description Register	Name of Register	Register	Value	Notes	
INIT	Reset	Hardware-Reset	Low for 1ms, then wait 10ms on High level			
	Must	PLL Control Register	PLLC1	0x88	0x06	wait 200µs
		PLL Control Register	PLLC2	0x89	0x02	wait 200µs
		System Configuration Register	SYSR	0x10	0x0c	wait 200µs
		Pixel Clock Setting Register	PCSR	0x04	0x81	wait 200µs
		LCD Horizontal Display Register	HDWR	0x14	0x63	
			HNDFTR	0x15	0x03	
			HNDR	0x16	0x03	
			HSTR	0x17	0x02	
			HPWR	0x18	0x00	
		LCD Vertical Display Register	VDHR0	0x19	0xdf	
			VDHR1	0x1a	0x01	
			VNDR0	0x1b	0x14	
			VNDR1	0x1c	0x00	
			VSTR0	0x1d	0x06	
			VSTR1	0x1e	0x00	
			VPWR	0x1f	0x01	
		Set active window X	HSAW0 / HSAW1	0x30	0x00	max size is 320
				0x31	0x00	
	0x34			0x1f		
	0x35			0x03	wait 100µs	
	Set active window Y	VSAW0 / VSAW1	0x32	0x00	max size is 240	
			0x33	0x00		
			0x36	0xdf		
			0x37	0x01		wait 100µs
	Optional	Memory Clear Control Register	MCLR	0x8e	0x80	check until bit7 of reg 0x8e is cleared
		Key-Scan Control Register 1	KSCR1	0xc0	0x80	KeyScan enable
		Touch Panel register	TPCR0 / TPCR1	0x70	0xd2	
				0x71	0x05	
		Interrupt Control Register	INTC1 / INTC2	0xf0	0x16	Key/DMA/Touch Int
Memory Write Control Register 0		MWCR0	0xf1	0x16	wait 100µs	
Display Configuration Register	DPCR	0x40	0x00	Graphic mode		
Must	PWM1 Register (Backlight)	P1CR	0x8a	0xc9	0x00: 1 Layer 0x80: 2 Layer	
			0x8b	0xff		0xFF: max. backlight
	Power & Display Contr. Register	PWRR	0x01	0x80	Display ON	

Download for code ITM1050: www.ibsdisplay.de


11.3 Command - Drive Backlight

Function	Description	Register	Value	Notes
Set PWM for backlight	PWM Control Register	0x8a	Bit 7	PWM1 Enable
			Bit 6	PWM1 Disable Level
			Bit 4	PWM1 Function Selection
			Bit 3-0	PWM1 Clock Source Divide Ratio
	PWM Duty Cycle Register	0x8b	PWM Cycle Duty	0...255 ⇒ 1/256...256/256 Duty with PWM1 clock source


Note:  PWM2 could be used for external applications on connector P2/pin3 (control register: 0x8c / duty cycle reg: 0x8d)

 [back to page 1 \(Index\)](#)


11.4 Command – **Set ACTIVE WINDOW**

Function	Description	Register	Value	Notes
Set active window		0x30	Pos.X0	Low byte
		0x31		High Byte
		0x32	Pos.Y0	Low byte
		0x33		High Byte
		0x34	Pos.X1	Low byte
		0x35		High Byte
		0x36	Pos.Y1	Low byte
		0x37		High Byte

11.5 Command – **Draw PIXEL/DOT**


Function	Description	Register	Value	Notes
Draw pixel/dot		0x46	Pos.X	Low byte
		0x47		High Byte
		0x48	Pos.Y	Low byte
		0x49		High Byte
		0x02	Color	High Byte → Low byte

11.6 Command – **Draw LINE**

Function	Description	Register	Value	Notes
Draw line		0x91	Pos.X0	Low byte
		0x92		High Byte
		0x93	Pos.Y0	Low byte
		0x94		High Byte
		0x95	Pos.X1	Low byte
		0x96		High Byte
		0x97	Pos.Y1	Low byte
		0x98		High Byte
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0x90	0x80	Execute draw line

Note: After execute command 0x90:0x80, please check until bit7 of register 0x90 is cleared.

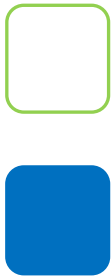
11.7 Command – **Draw RECTANGLE**

Function	Description	Register	Value	Notes
Draw rectangle		0x91	Pos.X0	Low byte
		0x92		High Byte
		0x93	Pos.Y0	Low byte
		0x94		High Byte
		0x95	Pos.X1	Low byte
		0x96		High Byte
		0x97	Pos.Y1	Low byte
		0x98		High Byte
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0x90	0x90	Execute draw rect w/o fill
		0x90	0xB0	Execute draw rect with fill

Note: After execute command 0x90:0x90 or 0x90:0xB0, please check until bit7 of register 0x90 is cleared.

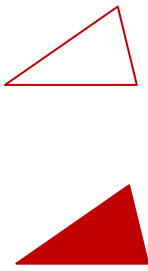
[↶ back to page 1 \(Index\)](#)

11.8 Command – Draw RECTANGLE with rounded corners

Function	Description	Register	Value	Notes
Draw rectangle		0x91	Pos.X0	Low byte
		0x92		High Byte
		0x93	Pos.Y0	Low byte
		0x94		High Byte
		0x95	Pos.X1	Low byte
		0x96		High Byte
		0x97	Pos.Y1	Low byte
		0x98		High Byte
		0xa1	Long radius	Low byte
		0xa2		High Byte
		0xa3	Short radius	Low byte
		0xa4		High Byte
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0xa0	0xa0	Execute draw rectangle w/o fill
			0xE0	Execute draw rectangle with fill

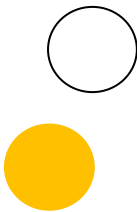
Note: After execute command 0xa0:0xa0 or 0xa0:0xE0, please check until bit7 of register 0xa0 is cleared.

11.9 Command – Draw TRIANGLE

Function	Description	Register	Value	Notes
Draw triangle		0x91	Pos.X0	Low byte
		0x92		High Byte
		0x93	Pos.Y0	Low byte
		0x94		High Byte
		0x95	Pos.X1	Low byte
		0x96		High Byte
		0x97	Pos.Y1	Low byte
		0x98		High Byte
		0xa9	Pos.X2	Low byte
		0xaa		High Byte
		0xab	Pos.Y2	Low byte
		0xac		High Byte
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0x90	0x81	Execute draw triangle w/o fill
			0xA1	Execute draw triangle with fill

Note: After execute command 0x90:0x81 or 0x90:0xA1, please check until bit7 of register 0x90 is cleared.

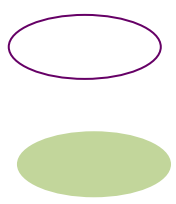
11.10 Command – Draw CIRCLE

Function	Description	Register	Value	Notes
Draw circle		0x99	Pos.X0	Low byte
		0x9a		High Byte
		0x9b	Pos.Y0	Low byte
		0x9c		High Byte
		0x9d	Rad	Radius 8-bit
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0x90	0x40	Execute draw circle w/o fill
			0x60	Execute draw circle with fill

Note: After execute command 0x90:0x40 or 0x90:0x60, please check until bit6 of register 0x90 is cleared.

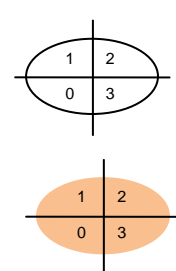
[back to page 1 \(Index\)](#)

11.11 Command – Draw ELLIPSE

Function	Description	Register	Value	Notes
Draw ellipse		0xa5	Pos.X0	Low byte
		0xa6		High Byte
		0xa7	Pos.Y0	Low byte
		0xa8		High Byte
		0xa1	Long radius	Low byte
		0xa2		High Byte
		0xa3	Short radius	Low byte
		0xa4		High Byte
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0xa0	0x80	Execute draw ellipse w/o fill
			0xC0	Execute draw ellipse with fill

Note: After execute command 0xa0:0x80 or 0xa:0xC0, please check until bit7 of register 0xa0 is cleared.

11.12 Command – Draw Segment of ELLIPSE

Function	Description	Register	Value	Notes
Draw segment of ellipse		0xa5	Pos.X0	Low byte
		0xa6		High Byte
		0xa7	Pos.Y0	Low byte
		0xa8		High Byte
		0xa1	Long radius	Low byte
		0xa2		High Byte
		0xa3	Short radius	Low byte
		0xa4		High Byte
		0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
		0xa0	0x90	Execute draw seg. ellipse w/o fill
			0xD0	Execute draw seg. ellipse with fill
			Bit0 and Bit1 define which segment is used Values: 0xD0...0xD3 or 0x90...0x93	

Note: After execute command 0xa0:0x90 or 0xa:0xD0, please check until bit7 of register 0xa0 is cleared.

11.13 Command – **Draw Text** (with internal Font-ROM)

Function	Description	Register	Value	Notes
Draw text	Set Font write cursor position	0x2a	Horizontal	Low byte
		0x2b		High byte
		0x2c	Vertical	Low byte
		0x2d		High byte
	Set background color	0x60	Color R	Color red 5-bit
		0x61	Color G	Color green 6-bit
		0x62	Color B	Color blue 5-bit
	Set foreground color	0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
	Font control register 0	0x21	Bit 7	CGRAM/CGROM Font Selection Bit
			Bit 5	External/Internal CGROM Selection Bit
			Bit 1..0	Font Selection for internal CGROM
	Font control register 1	0x22	Bit 7	Full Alignment Selection Bit
			Bit 6	Font Transparency
			Bit 4	Font Rotation
			Bit 3..2	Horizontal Font Enlargement
			Bit 1..0	Vertical Font Enlargement
	Font Line Distance Setting	0x29	Bi7 4..0	Font Line Distance Setting
	Font Write Type Setting	0x2e	Bit 7..6	Font Size Setting
Bit 5..0			Font to Font Width Setting	
Memory Write Control Reg0	0x40	Bit 7	1: Text Mode Enable	
Memory Read/Write Command	0x02	Text char	data can be written (continuously)	
Memory Write Control Reg0	0x40	Bit 7	0 : Graphic mode (if necessary)	

Note: Text-cursor-position should be in active window

11.13.1 ASCII Block 1 (ISO/IEC 8859-1 → LATIN1)

H/L	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0		☺	☹	♥	♦	♣	♠	●	◻	◯	◼	♂	♀	🎵	🎶	☼
1	▶	◀	↕	!!	¶	§	▬	⤴	⤵	→	←	↔	▲	▼		
2	SP	!	"	#	\$	%	&	'	()	*	+	,	-	.	/
3	0	1	2	3	4	5	6	7	8	9	:	;	<	=	>	?
4	@	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O
5	P	Q	R	S	T	U	V	W	X	Y	Z	[\]	^	_
6	`	a	b	c	d	e	f	g	h	i	j	k	l	m	n	o
7	p	q	r	s	t	u	v	w	x	y	z	{		}	~	
8																
9																
A		ı	ç	€	¤	¥	¦	§	¨	©	ª	«	¬	®	¯	
B	°	±	²	³	´	µ	¶	·	¸	¹	º	»	¼	½	¾	¿
C	À	Á	Â	Ã	Ä	Å	Æ	Ç	È	É	Ê	Ë	Ì	Í	Î	Ï
D	Ð	Ñ	Ò	Ó	Ô	Õ	Ö	×	Ø	Ù	Ú	Û	Ü	Ý	Þ	ß
E	à	á	â	ã	ä	å	æ	ç	è	é	ê	ë	ì	í	î	ï
F	ð	ñ	ò	ó	ô	õ	ö	÷	ø	ù	ú	û	ü	ý	þ	ÿ

Possible languages: Western Europe, includes Albanian, Afrikaans, Breton, Danish, Faroese, Frisian, Galician, German, Greenlandic, Icelandic, Irish, Italian, Latin, Luxembourgish, Norwegian, Portuguese, Rhaeto-Romanic, Scottish Gaelic, Spanish, Swedish.

11.13.2 ASCII Block 2 (ISO/IEC 8859-2 → LATIN2)

H/L	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0		☺	☹	♥	♦	♣	♠	●	◻	◯	◼	♂	♀	🎵	🎶	☼
1	▶	◀	↕	!!	¶	§	▬	⤴	⤵	→	←	↔	▲	▼		
2	SP	!	"	#	\$	%	&	'	()	*	+	,	-	.	/
3	0	1	2	3	4	5	6	7	8	9	:	;	<	=	>	?
4	@	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O
5	P	Q	R	S	T	U	V	W	X	Y	Z	[\]	^	_
6	`	a	b	c	d	e	f	g	h	i	j	k	l	m	n	o
7	p	q	r	s	t	u	v	w	x	y	z	{		}	~	
8																
9																
A	SP	À	Á	Â	Ã	Ä	Å	Š	Š	Š	Š	Š	Š	Š	Š	Š
B	°	à	á	â	ã	ä	å	š	š	š	š	š	š	š	š	š
C	Ř	Á	Â	Ã	Ä	Å	Č	Č	Č	Č	Č	Č	Č	Č	Č	Č
D	Ð	Ñ	Ò	Ó	Ô	Õ	Ö	×	Ř	Ú	Ú	Ú	Ú	Ú	Ú	Ú
E	ř	á	â	ã	ä	å	č	č	č	é	é	é	é	é	é	é
F	đ	ñ	ñ	ó	ô	õ	ö	÷	ř	ú	ú	ú	ú	ú	ú	ú

Possible languages: Croatian, Czech, Hungarian, Polish, Slovak, Slovenian and Upper Sorbian. The Serbian, English, German, Latin can use ISO/IEC 8859-2 as well. It is suitable to represent some western European languages like Finnish (with the exception of å used in Swedish and Finnish)

[back to page 1 \(Index\)](#)

11.13.3 ASCII Block 3 (ISO/IEC 8859-3 → South European)

H/L	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0		☺	☹	♥	♦	♣	♠	●	◻	◯	◻	♂	♀	🎵	🎶	☀
1	▶	◀	↕	!!	¶	§	▬	⤴	⤵	↓	→	←	↔	▲	▼	
2	SP	!	"	#	\$	%	&	'	()	*	+	,	-	.	/
3	0	1	2	3	4	5	6	7	8	9	:	;	<	=	>	?
4	@	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O
5	P	Q	R	S	T	U	V	W	X	Y	Z	[\]	^	_
6	`	a	b	c	d	e	f	g	h	i	j	k	l	m	n	o
7	p	q	r	s	t	u	v	w	x	y	z	{		}	~	
8																
9																
A	SP	Ħ	˘	£	¤		Ĥ	§	¨	İ	Ş	Ğ	Ĵ			Ž
B	°	ħ	²	³	´	µ	ĥ	·	¸	ı	ş	ğ	ĵ	½		ž
C	À	Á	Â		Ä	Å	Ç	È	É	Ê	Ë	Ì	Í	Î	Ï	
D		Ñ	Ò	Ó	Ô	Õ	Ö	×	Ø	Ù	Ú	Û	Ü	Ý	ß	
E	à	á	â		ä	å	ç	è	é	ê	ë	ì	í	î	ï	
F		ñ	ò	ó	ô	õ	ö	÷	ø	ù	ú	û	ü	ý	ÿ	

Possible languages: Turkish, Maltese and Esperanto
 It also supports English, German, Italian, Latin and Portuguese.

11.13.4 ASCII Block 4 (ISO/IEC 8859-3 → North European)

H/L	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0		☺	☹	♥	♦	♣	♠	●	◻	◯	◻	♂	♀	🎵	🎶	☀
1	▶	◀	↕	!!	¶	§	▬	⤴	⤵	↓	→	←	↔	▲	▼	
2	SP	!	"	#	\$	%	&	'	()	*	+	,	-	.	/
3	0	1	2	3	4	5	6	7	8	9	:	;	<	=	>	?
4	@	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O
5	P	Q	R	S	T	U	V	W	X	Y	Z	[\]	^	_
6	`	a	b	c	d	e	f	g	h	i	j	k	l	m	n	o
7	p	q	r	s	t	u	v	w	x	y	z	{		}	~	
8																
9																
A	SP	À	Ā	Ṛ	¤	İ	Ł	§	¨	Š	Ē	Ģ	ƒ			Ž
B	°	à	á	â	ã	ä	å	æ	ç	ĉ	ē	ģ	ƒ	Đ	ž	ŋ
C	Ā	Á	Ā	Ā	Ä	Å	Æ	Į	Č	É	Ē	Ģ	ƒ	İ	Ī	
D	Ð	Ñ	Ò	Ë	Ô	Õ	Ö	×	Ø	Ù	Ú	Û	Ü	Ý	ß	
E	ā	á	â	ã	ä	å	æ	į	č	é	ē	ģ	ƒ	ı	ī	
F	đ	ñ	ò	ë	ô	õ	ö	÷	ø	ù	ú	û	ü	ý	ÿ	

Possible languages: Estonian, Greenlandic, Latvian, Lithuanian, and Sami.
 It also supports Danish, English, Finnish, German, Latin, Norwegian, Slovenian and Swedish

11.14 Command – **Draw Text** (with optional external Font-ROM)

For detailed information's about available external FONT-ROM IC please contact IbS Sperleng.

Function	Description	Register	Value	Notes
Draw text	Set Font write cursor position	0x2a	Horizontal	Low byte
		0x2b		High byte
		0x2c	Vertical	Low byte
		0x2d		High byte
	Set background color	0x60	Color R	Color red 5-bit
		0x61	Color G	Color green 6-bit
		0x62	Color B	Color blue 5-bit
	Set foreground color	0x63	Color R	Color red 5-bit
		0x64	Color G	Color green 6-bit
		0x65	Color B	Color blue 5-bit
	Font control register 0	0x21	Bit 7	CGRAM/CGROM Font Selection Bit
			Bit 5	External/Internal CGROM Selection Bit
			Bit 1..0	Font Selection for internal CGROM
	Font control register 1	0x22	Bit 7	Full Alignment Selection Bit
			Bit 6	Font Transparency
			Bit 4	Font Rotation
			Bit 3..2	Horizontal Font Enlargement
	Font Line Distance Setting	0x29	Bit 1..0	Vertical Font Enlargement
			Bit 4..0	Font Line Distance Setting
	Font Write Type Setting	0x2e	Bit 7..6	Font Size Setting
Bit 5..0			Font to Font Width Setting	
Serial Font ROM Setting	0x2f	Bit 7..5	Serial Font ROM Select	
		Bit 4..2	FONT ROM Coding Setting	
		Bit 1..0	ASCII/Latin/Greek/Cyrillic/Arabic	
Serial Flash/ROM Configuration	0x05		See Spec RA8875	
Serial Flash/ROM CLK Setting	0x06			
Memory Write Control Reg0	0x40	Bit 7	1: Text Mode Enable	
Memory Read/Write Command	0x02	Text char	data can be written (continuously)	
Memory Write Control Reg0	0x40	Bit 7	0 : Graphic mode (if necessary)	

Note: Text-cursor-position should be in active window

11.15 Command – **SCROLL**

Function	Description	Register	Value	Notes	
SCROLL	Set scroll window	0x38	Left	Low byte	
		0x39		High Byte	
		0x3a	Top	Low byte	
		0x3b		High Byte	
		0x3c	Right	Low byte	
		0x3d		High Byte	
		0x3e	Bottom	Low byte	
		0x3f		High Byte	
	Horizontal Scroll Offset Register	0x24	0x24	Horizontal Scroll-Offset	Low byte
			0x25		High Byte
	Vertical Scroll Offset Register	0x26	0x26	Vertical Scroll-Offset	Low byte
			0x27		High Byte

[back to page 1 \(Index\)](#)

11.16 Command – **WRITE transparent BTE**

i BTE → Block Transfer Engine
 ROP→ Raster Operation

Function	Description	Register	Value	Notes
WRITE transparent BTE	Memory Write Control Reg0	0x40	Bit7	0: Graphic mode
	Destination Point of BTE	0x58	Horizontal	Low byte
		0x59		High Byte
		0x5a	Vertical	Low byte
		0x5b		High Byte
	BTE Width Register	0x5c	Width	Low byte
		0x5d		High Byte
	BTE Height Register	0x5e	Height	Low byte
		0x5f		High Byte
	Set transparent color	0x63	Color Red	Color red 5-bit
		0x64	Color Green	Color green 6-bit
		0x65	Color Blue	Color blue 5-bit
	BTE Function Control Register1	0x51	Bit 7..4 (0xc0)	BTE ROP Code
			Bit 3..0 (0x04)	BTE Operation Code
	BTE Function Control Register0	0x50	Bit 7 (0x80)	BTE Function Enable / Status
Bit 6 (0x00)			BTE Source Data Select	
Bit 5 (0x00)			BTE Destination Data Type Select	
<i>Now you must write all your image-data to RAIO in a loop:</i> - Select RAIO-register 0x02 and send 16-bit-color-data (for 16-bit-color) of image-pixel to RAIO. - Wait while RAIO is busy. - Repeat for all pixel <i>Check BTE-busy in RAIO-status register and wait while busy.</i>				

11.17 Command – **MOVE transparent BTE**

Function	Description	Register	Value	Notes	
MOVE transparent BTE	Memory Write Control Reg0	0x40	Bit7	0: Graphic mode	
	<i>Place your picture now</i>				
	Source Point of BTE (the left/top position of your picture)	0x54	Horizontal	Low byte	
		0x55		High Byte	
		0x56	Vertical	Low byte	
		0x57		High Byte	
	Destination Point of BTE	0x58	Horizontal	Low byte	
		0x59		High Byte	
		0x5a	Vertical	Low byte	
		0x5b		High Byte	
	BTE Width Register	0x5c	Width	Low byte	
		0x5d		High Byte	
	BTE Height Register	0x5e	Height	Low byte	
		0x5f		High Byte	
	Set transparent color	0x63	Color Red	Color red 5-bit	
		0x64	Color Green	Color green 6-bit	
		0x65	Color Blue	Color blue 5-bit	
	BTE Function Control Register1	0x51	Bit 7..4 (0x00)	BTE ROP Code	
Bit 3..0 (0x05)			BTE Operation Code		
BTE Function Control Register0	0x50	Bit 7 (0x80)	BTE Function Enable / Status		
		Bit 6 (0x00)	BTE Source Data Select		
		Bit 5 (0x00)	BTE Destination Data Type Select		
<i>Check BTE-busy in RAIO-status register and wait while busy!</i>					

[i](#) back to page 1 (Index)

11.18 **IMAGE** handling

Following definitions are made for IBS Terminal tool named "ITM Picture converter".

11.18.1 Store picture in FLASH

The optional FLASH memories on module series ITM1035 could be written by SPI 4-wire mode with file in binary format. A tool for easy handling is available at IBS Sperlring – please contact!

Following handling is necessary!:

1. Connect as follows:

Signal	Description	Connector:Pin
U _{IN} (3.3VDC)	Power supply	P2:1
VSS (0V)		P2:16
SPI-/CS	Chip select	P2:12
SPI-SDO	Serial data out	P2:13
SPI-SDI	Serial data in	P2:14
SPI-SCL	Serial clock	P2-15
/PROG	Program mode	P2-17
SELFLA	Select Flash-IC 1 or 2	P2-18

2. Select Flash memory you want by signal SELFLA (max 2 IC are optional possible)
3. Set signal /PROG to LOW (now is no function of module possible)
4. Please send data to FLASH (for timing please refer spec of FLASH IC)
5. After program FLASH set signal /PROG to high (functions of module are reactivated)

11.18.2 Show picture from FLASH

Agreements for images in FLASH:

1. All picture are stored in FLASH memory in binary format
2. Each picture consist of header and image data

Header consist of:

Item	Value	Example
Identifier	8 Byte	"ITMIMAGE"
Size	4 Byte	0xFFFFFFFF
Width	2 Byte	320
Height	2 Byte	240
Flag	2 Byte	2x 2Byte for color (16Bit-Farben)
Name	12 Byte	"name of your picture"
Checksum	2 Byte	Checksum of header (issues above)

Data consist of:

Item	Value	Example
Data of image	As requested	Data of image
Checksum	4 Byte	at present unused

3. 1st picture starts with address 0x1000
4. Header of each following image in FLASH begins at address alignment 0x?????0
 - e.g. 1st picture starts at 0x1000
 - calculation of 1st picture:
 - size: 163x51 pixel (2Byte/pixel) → 16626Byte (0x40F2)
 - total size: 16626Byte + 32Byte(Header) + 4Byte(Checksum)=16662Byte (0x4116)
 - address of 1st picture ends at: 0x1000(start 1st pic) + 0x4116 = **0x5116**
 - address of header 2nd picture starts at: **0x5120** ←

5. Calculation for address of requested image in FLASH with RAIO registers:

Register	Name of Register	Register	Value	Notes
Serial Flash/ROM Configuration Register	SROC	0x05	0x04	FLASH1
			0x84	FLASH2
Serial Flash/ROM CLK Setting Register	SFCLR	0x06	0x03	
Serial Flash/ROM Direct Access Mode	SACS_MODE	0xe0	0x01	direct access
Serial Flash/ROM Direct Access Mode Address	SACS_ADDR	0xe1	addr16..23	24-bit address data (0x1000)
			addr8..15	
			addr0..7	
Serial Flash Direct Access Data Read	SACS_DATA	0xe2	read 33 Byte, ignore 1 st Dummy byte! Header has 32 byte	
Serial Flash/ROM Direct Access Mode	SACS_MODE	0xe0	0x00	disable direct access mode
Following instruction must realized by microcontroller: <ul style="list-style-type: none"> • Check for valid first header (starts at 0x1000) • If check is valid, in header you find dim of image (see issue 2 above) • Now you could calculate for address of next image (see issue 4 above) • After this calc you could calculate for next picture a.s.o. 				

6. Show the selected picture with RAIO registers:

(example: image 1 has 320x240pixel at position 0,0)

Register	Name of Register	Register	Value	Notes
Memory Write Control Register 0	MWCRO	0x40	Bit7=0	Graphic mod
Set active window	HSAW0 / HSAW1	0x30	0x00	Start left (0)
		0x31	0x00	
		0x34	0xa2	End right (162 (W))
		0x35	0x00	
	VSAW0 / VSAW1	0x32	0x00	Start top (0)
		0x33	0x00	
		0x36	0x32	End bottom (50 (H))
0x37	0x00			
Memory Write Cursor Horizontal Position Register	CURH0	0x46	0x00	Set cursor to position 0,0
	CURH1	0x47		
Memory Write Cursor Vertical Position Register	CURV0	0x48		
	CURV1	0x49		
Serial Flash/ROM CLK Setting Register	SFCLR	0x06	0x03	
Serial Flash/ROM Configuration Register	SROC	0x05	0x04	FLASH1
			0x84	FLASH2
Source Start Address	SSAR	0xb0	0x40	Start-addr of image in Flash
		0xb1	0x51	
		0xb2	0x00	
Block Width	BWR0/ BWR1	0xb4	0xa3	Image= 163pixel (W)
		0xb5	0x00	
Block Height	BHR0/ BHR1	0xb6	0x33	Image= 51pixel (H)
		0xb7	0x00	
Source Picture Width	SPWR0/ SPWR1	0xb8	0xa3	Image= 163pixel (W)
		0xb9	0x00	
DMA Configuration	DMACR	0xbf	0x03	Start DMA

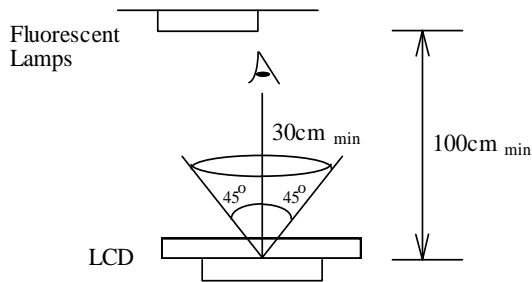
Note: After execute command 0xbf:0x03, please check until bit0 of register 0xbf is cleared.

12. Quality Specifications

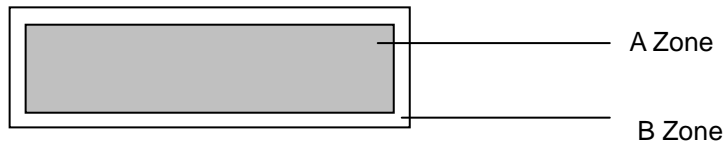
12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



LCM Definition of zone:



A Zone: Active display area (minimum viewing area)
 B Zone: Non-active display area (outside viewing area).

12.2 Specification of quality assurance

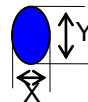
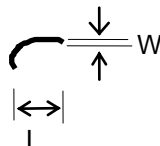
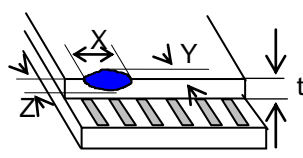
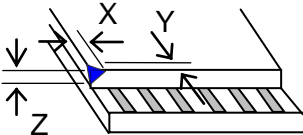
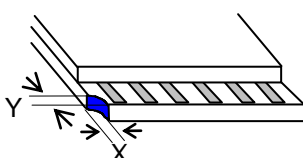
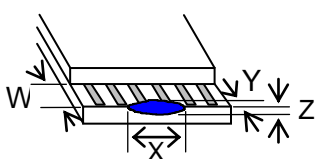
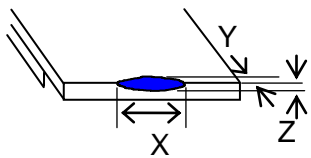
AQL inspection standard

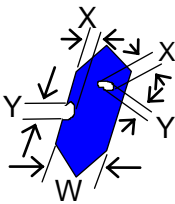
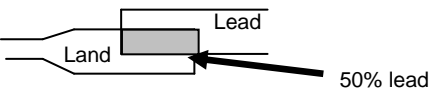
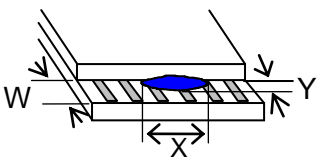
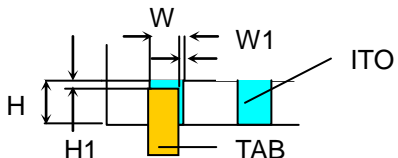
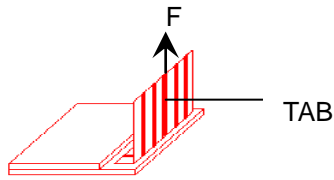
Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify	Item		Note	AQL		
Major	Display state	Short or open circuit	1	0.65		
		LC leakage				
		Flickering				
		No display				
		Wrong viewing direction				
		Contrast defect (dim, ghost)	2			
		Back-light	1,8			
	Non-display	Flat cable or pin reverse	10			
		Wrong or missing component	11			
		Minor	Display state	Background color deviation	2	1.0
				Black spot and dust	3	
Line defect, Scratch	4					
Rainbow	5					
Chip	6					
		Pin hole	7			
		Protruded	12			
	Polarizer	Bubble and foreign material	3			
	Soldering	Poor connection	9			
	Wire	Poor connection	10			
	TAB	Position, Bonding strength	13			

Note on defect classification

No.	Item	Criterion																				
1	Short or open circuit	Not allow																				
	LC leakage																					
	Flickering																					
	No display																					
	Wrong viewing direction																					
	Wrong Back-light																					
2	Contrast defect	Refer to approval sample																				
	Background color deviation																					
3	Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$	 Unit: mm	<table border="1"> <thead> <tr> <th>Point Size</th> <th>Acceptable Qty.</th> </tr> </thead> <tbody> <tr> <td>$\phi \leq 0.10$</td> <td>Disregard</td> </tr> <tr> <td>$0.10 < \phi \leq 0.20$</td> <td>3</td> </tr> <tr> <td>$0.20 < \phi \leq 0.25$</td> <td>2</td> </tr> <tr> <td>$0.25 < \phi \leq 0.30$</td> <td>1</td> </tr> <tr> <td>$\phi > 0.30$</td> <td>0</td> </tr> </tbody> </table>	Point Size	Acceptable Qty.	$\phi \leq 0.10$	Disregard	$0.10 < \phi \leq 0.20$	3	$0.20 < \phi \leq 0.25$	2	$0.25 < \phi \leq 0.30$	1	$\phi > 0.30$	0							
			Point Size	Acceptable Qty.																		
			$\phi \leq 0.10$	Disregard																		
			$0.10 < \phi \leq 0.20$	3																		
			$0.20 < \phi \leq 0.25$	2																		
$0.25 < \phi \leq 0.30$	1																					
$\phi > 0.30$	0																					
4	Line defect, Scratch	 Unit: mm	<table border="1"> <thead> <tr> <th colspan="2">Line</th> <th>Acceptable Qty.</th> </tr> </thead> <tbody> <tr> <td>L</td> <td>W</td> <td rowspan="2">Disregard</td> </tr> <tr> <td>---</td> <td>$0.015 \geq W$</td> </tr> <tr> <td>$3.0 \geq L$</td> <td>$0.03 \geq W$</td> <td rowspan="2">2</td> </tr> <tr> <td>$2.0 \geq L$</td> <td>$0.05 \geq W$</td> </tr> <tr> <td>$1.0 \geq L$</td> <td>$0.1 > W$</td> <td>1</td> </tr> <tr> <td>---</td> <td>$0.05 < W$</td> <td>Applied as point defect</td> </tr> </tbody> </table>	Line		Acceptable Qty.	L	W	Disregard	---	$0.015 \geq W$	$3.0 \geq L$	$0.03 \geq W$	2	$2.0 \geq L$	$0.05 \geq W$	$1.0 \geq L$	$0.1 > W$	1	---	$0.05 < W$	Applied as point defect
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5	Rainbow	Not more than two color changes across the viewing area.																				
6	Chip Remark: X: Length direction Y: Short direction Z: Thickness direct. t: Glass thickness W: Terminal Width		<p>Acceptable criterion</p> <table border="1"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤ 2</td> <td>0.5mm</td> <td>$\leq t/2$</td> </tr> </tbody> </table>	X	Y	Z	≤ 2	0.5mm	$\leq t/2$													
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No.	Item	Criterion								
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	<p>(1) Pin hole $\phi < 0.10\text{mm}$ is acceptable.</p>  <table border="1" data-bbox="965 331 1428 492"> <thead> <tr> <th>Point Size</th> <th>Acceptable Qty</th> </tr> </thead> <tbody> <tr> <td>$\phi \leq 1/4W$</td> <td>Disregard</td> </tr> <tr> <td>$1/4W < \phi \leq 1/2W$</td> <td>1</td> </tr> <tr> <td>$\phi > 1/2W$</td> <td>0</td> </tr> </tbody> </table> <p>Unit: mm</p>	Point Size	Acceptable Qty	$\phi \leq 1/4W$	Disregard	$1/4W < \phi \leq 1/2W$	1	$\phi > 1/2W$	0
Point Size	Acceptable Qty									
$\phi \leq 1/4W$	Disregard									
$1/4W < \phi \leq 1/2W$	1									
$\phi > 1/2W$	0									
8	Back-light	The color of backlight should correspond its specification. Not allow flickering								
9	Soldering	Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) Over 50% of lead should be soldered on Land.								
										
10	Wire	Copper wire should not be rusted Not allow crack on copper wire connection. Not allow reversing the position of the flat cable. Not allow exposed copper wire inside the flat cable.								
11	PCB	Not allow screw rust or damage. Not allow missing or wrong putting of component.								
12	Protruded W: Terminal Width	 <p>Acceptable criteria: $Y \leq 0.4$</p>								
13	TAB	<p>1. Position</p>  <div style="border: 1px solid black; padding: 5px; width: fit-content; margin: 10px auto;"> $W1 \leq 1/3W$ $H1 \leq 1/3H$ </div> <p>B bonding strength test</p>  <p>$P (=F/\text{TAB bonding width}) \geq 650\text{gf/cm}$,(speed rate: 1mm/min) 5pcs per SOA (shipment)</p>								
14	Total no. of acceptable Defect	<p>A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm</p> <p>B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.</p>								

12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time(hrs)	Assessment
High temp. Storage	80°C	48	No abnormalities in functions and appearance
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	
Low temp. Operating	-20°C	48	
Humidity	40°C/ 90%RH	48	
Temp. Cycle	0°C ← 25°C → 50°C (30 min ← 5 min → 30min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

12.4.1 General Precaution

LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.

The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isopropyl alcohol, ethyl alcohol or trichlorotrifluoroethane, do not use water, ketone or aromatics and never scrub hard.

Do not tamper in any way with the tabs on the metal frame.

Do not make any modification on the PCB without consulting OCULAR ENTERPRISES

When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.

Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

12.4.2 Static Electricity Precaution

CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.

Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.

Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.

The modules should be kept in anti-static bags or other containers resistant to static for storage.

Only properly grounded soldering irons should be used.

If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.

The normal static prevention measures should be observed for work clothes and working benches. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

12.4.3 Soldering Precaution

Soldering should be performed only on the I/O terminals.
Use soldering irons with proper grounding and no leakage.
Soldering temperature: 280°C+10°C
Soldering time: 3 to 4 second.
Use eutectic solder with resin flux filling.
If flux is used, the LCD surface should be protected to avoid spattering flux.
Flux residue should be removed.

12.4.4 Operation Precautions

1. The viewing angle can be adjusted by varying the LCD driving voltage V_o .
2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
4. Response time increases with decrease in temperature.
5. Display color may be affected at temperatures above its operational range.
6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
7. For long-term storage over 40°C is required, the relative humidity should be kept below 60% and avoid direct sunlight.

12.5 Limited Warranty

OCULAR ENTERPRISES LCDs and modules are not consumer products, but may be incorporated by OCULAR ENTERPRISES's customers into consumer products or components thereof, OCULAR ENTERPRISES does not warrant that its LCDs and components are fit for any such particular purpose.

1. The liability of OCULAR ENTERPRISES is limited to repair or replacement on the terms set forth below. OCULAR ENTERPRISES will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between OCULAR ENTERPRISES and the customer, OCULAR ENTERPRISES will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with OCULAR ENTERPRISES general LCD inspection standard . (Copies available on request)
2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.